

## TECHNICAL DATA SHEET



### EpoxEase Mold Release Bulk/Liquid 40601HB, 40605HB, 40655HB

#### Product Description

EpoxEase is a synthetic wax-based, non-silicone release. It is formulated to prevent the sticking commonly seen when using all-purpose release agents on epoxies, maximizing your productivity. Ideal for use on epoxy, polyester and phenolic resins and most often utilized in encapsulating and potting applications.

#### Applications

Mold Release

#### Unit Package Description

1, 5 and 55-gallon containers

#### Generic Description

Mold Release for Epoxy Resins

#### Approx. Net Weight Fill per Gal.

9 pounds

#### Net Weight Fill

1 - 55 gallons

#### Appearance

Light-brown Oily Wax

#### Odor

Mild, Petroleum-like

#### Flash Point F

None

#### Flash Point C

None

#### Base Type

Wax

#### Evaporation Rate

Fast

#### HMIS Rating

2, 1, 0, B

#### DOT Proper Shipping Name

Not Regulated

#### VOC % (Federal)

91

#### VOC g/L (Federal)

981.38

#### VOC lbs./Gal (Federal)

8.19

#### Removal

Remove with organic or hydrocarbon solvents

#### Units Per Case

1

#### Case Weight (lbs)

Various

#### Working Temperature F

32 to 450 degrees

#### Working Temperature C

0 to 232 degrees

#### Specific Gravity

1.19